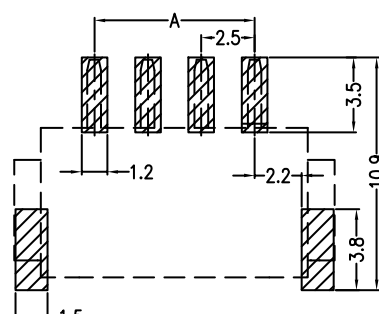
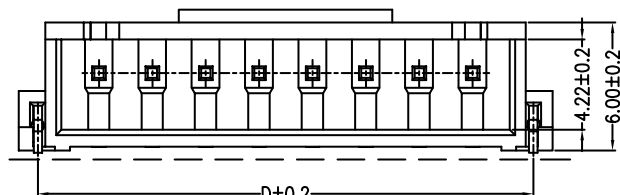


Assembly Layout

Main Specifications

- Contact resistance :  $\leq 20m\Omega$
- Insulation resistance :  $\geq 1000M\Omega$
- Rated voltage : 250V AC DC
- Rated current : 3.0A AC DC
- Withstand Voltage : 1000V AC/minute
- Temperature Range :  $-25^{\circ}C \sim +85^{\circ}C$



SUGGESTED PCB LAYOUT

Circuit	Dimensions(mm)				Circuit	Dimensions(mm)			
	A	B	C	D		A	B	C	D
02	2.50	7.50	10.00	8.20	10	22.50	27.50	30.00	28.20
03	5.00	10.00	12.50	10.70	11	25.00	30.00	32.50	30.70
04	7.50	12.50	15.00	13.20	12	27.50	32.50	35.00	33.20
05	10.00	15.00	17.50	15.70	13	30.00	35.00	37.50	35.70
06	12.50	17.50	20.00	18.20	14	32.50	37.50	40.00	38.20
07	15.00	20.00	22.50	20.70	15	35.00	40.00	42.50	40.70
08	17.50	22.50	25.00	23.20	16	37.50	42.50	45.00	43.20
09	20.00	25.00	27.50	25.70					

一般公差  
TOLERANCES  
X .±0.40 .XX ±0.20  
.X ±0.30 .XXX ±0.10  
ANGLES ±2°

深圳市宏利电子有限公司  
Shenzhen Holy Electronic Co.,Ltd

检验尺寸标示 SYMBOLS $\odot$ $\ominus$ INDICATE CLASSIFICATION DIMENSION $\odot$ MARK IS CRITICAL DIM. $\ominus$ MARK IS MAJOR DIM.	工程图号 XHB25WB-nP	制图 (DR) *12/5/16 审核 (CHKD)
品名 XHB2.5mm - nP 卧贴带扣	TITLE XHB2.5mm Pitch WB FOR SMT CONN	核准 (APPD) Rigo Lu
表面处理 (FINISH)	比例 (SCALE) 1:1	单位 (UNITS) mm
修订 REV	修改摘要 REVISION DESCRIPTION	日期 DATE
		签名 SIGNATURE
		张数 (SHEET) 1 OF 1
		尺寸 (SIZE) A4
		版本 (REV) 0